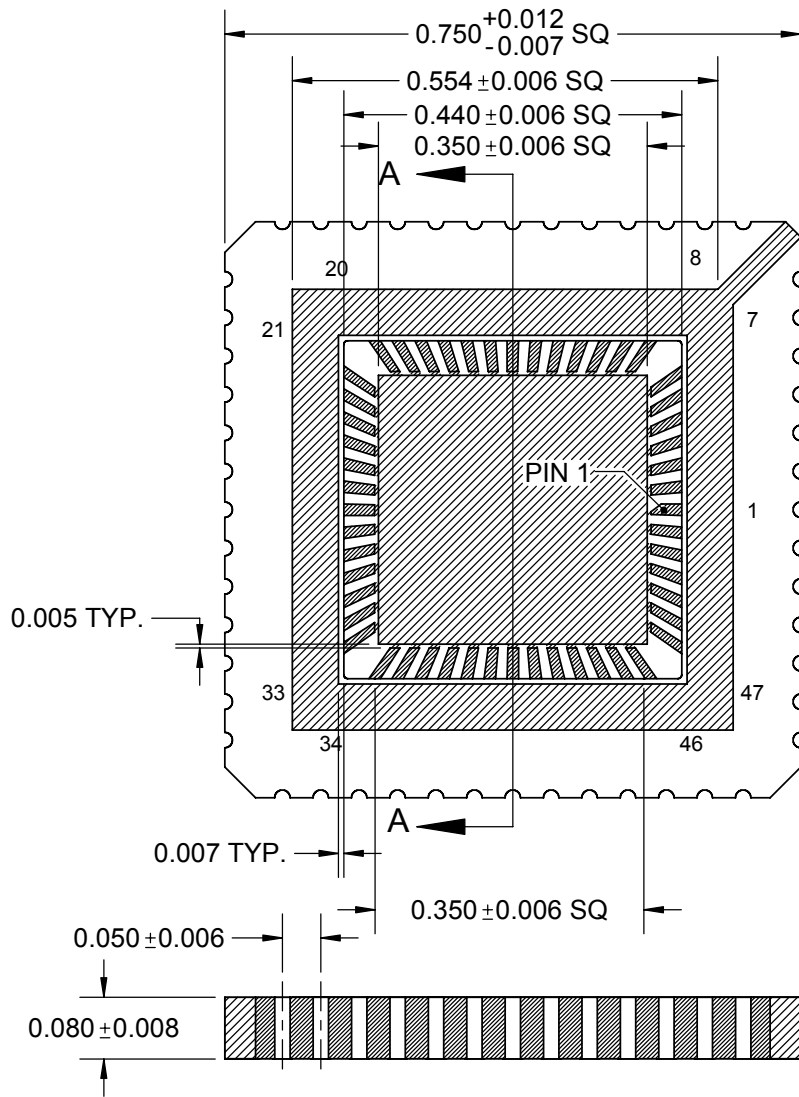
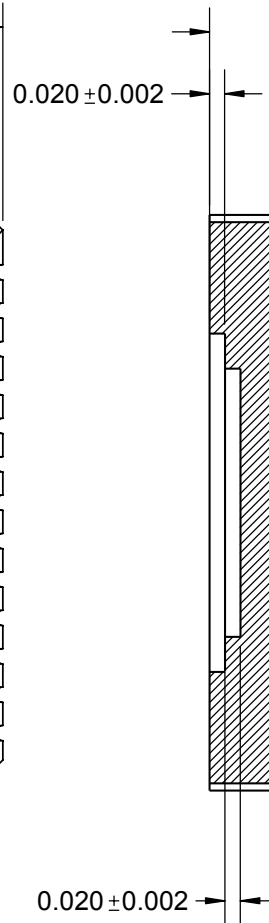


TOP VIEW

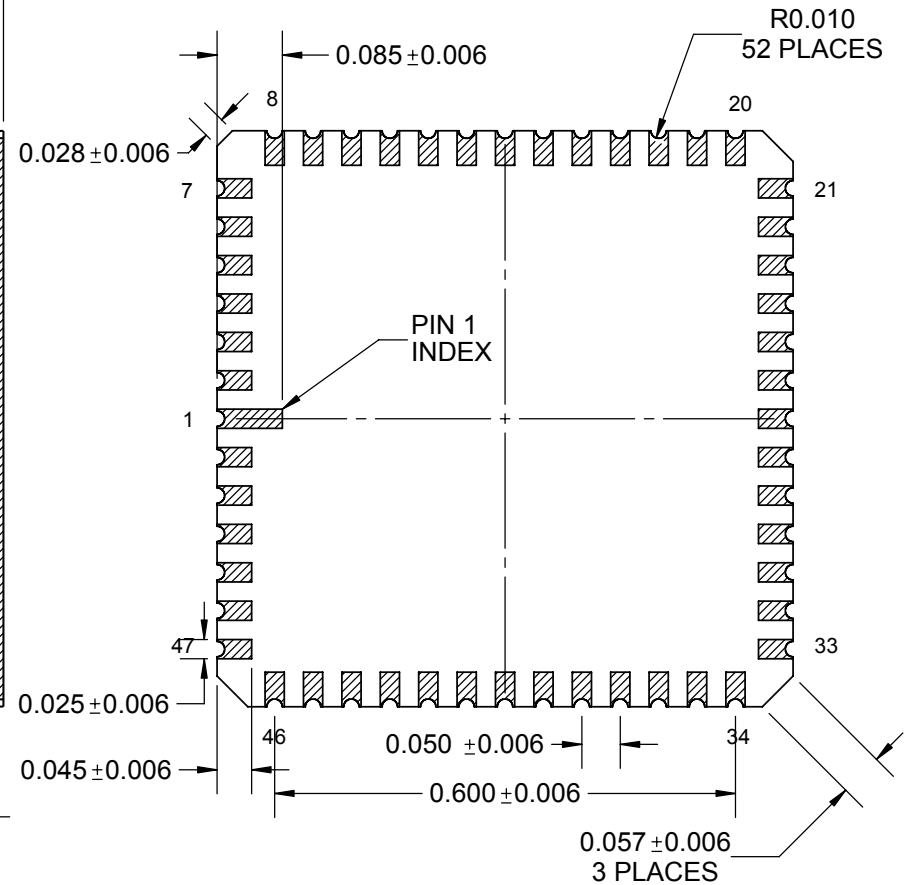


EDGE VIEW

SIDE VIEW



BOTTOM VIEW



Notes: (Unless Otherwise Specified).


1) PLATING:

Ni 80 MICRO-INCH (2.0µm) MIN.

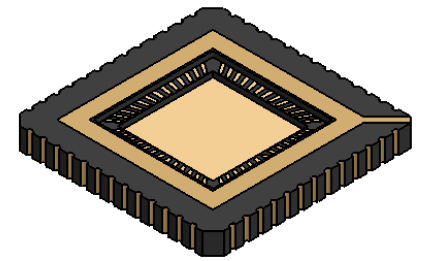
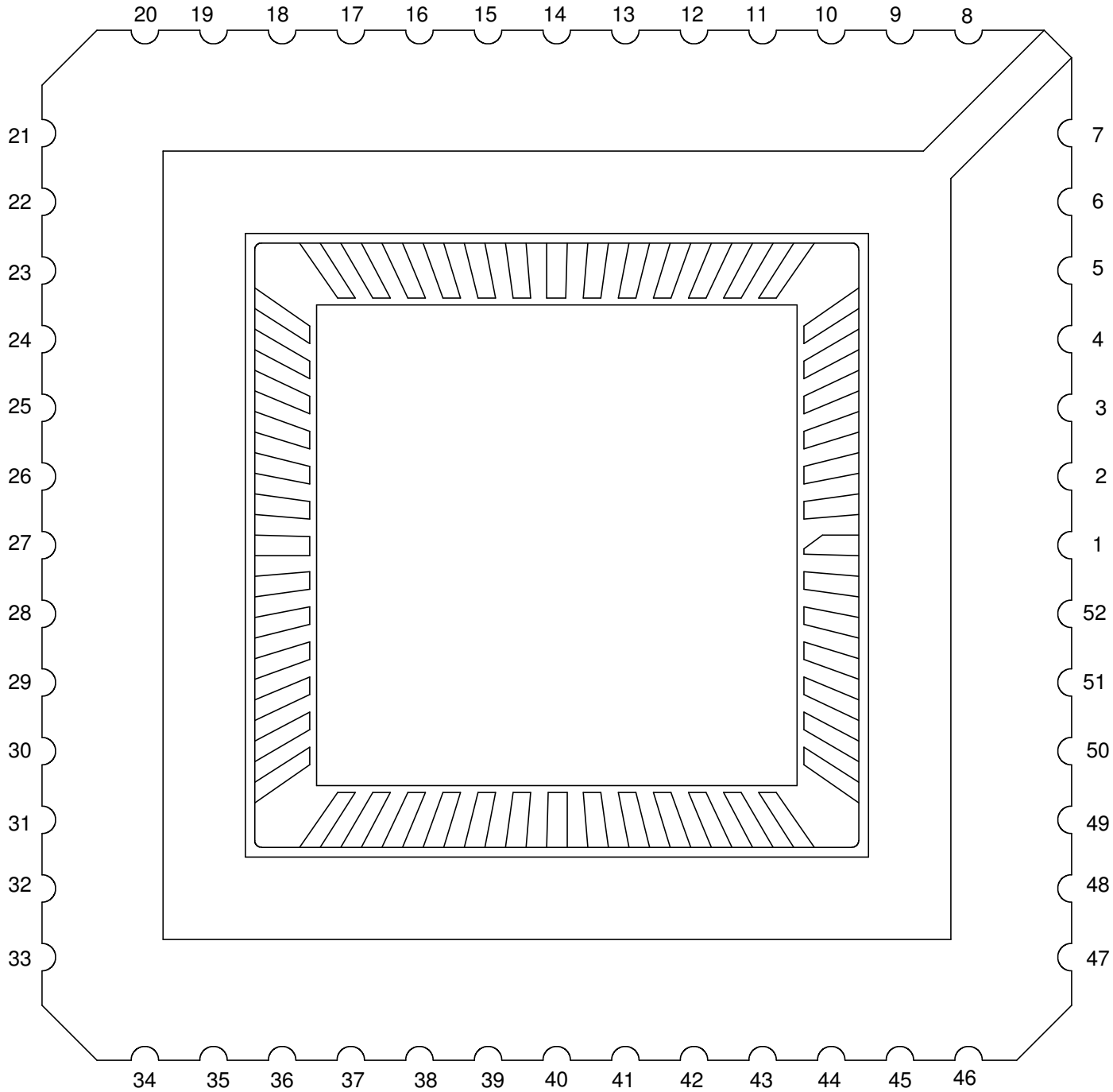
Au 60 MICRO-INCH (1.5µm) MIN.

2) DIMENSIONS in INCH (UNLESS SPECIFIED).

PART NUMBER	COVER	PLATING	DAISY CHAIN
LCC52B50SQ.75-N350	OPEN	NiAu	NO
LCC52B50SQ.75	SEALED	NiAu	NO
LCC52B50SQ.75-SC	SEALED	SnPb	NO
LCC52B50SQ.75-DE	SEALED	NiAu	YES
LCC52B50SQ.75-DE-SC	SEALED	SnPb	YES

APPROVALS	DATE				
DRAWN T. Au	10/31/2016				
ENG M. Hart	10/31/2016	TITLE LCC52B50SQ.75-N350			
MFG		SCALE 5:1	SIZE A	DRAWING NO. 169872	REV A
REVISD		DO NOT SCALE DRAWING			SHEET 1 OF 4

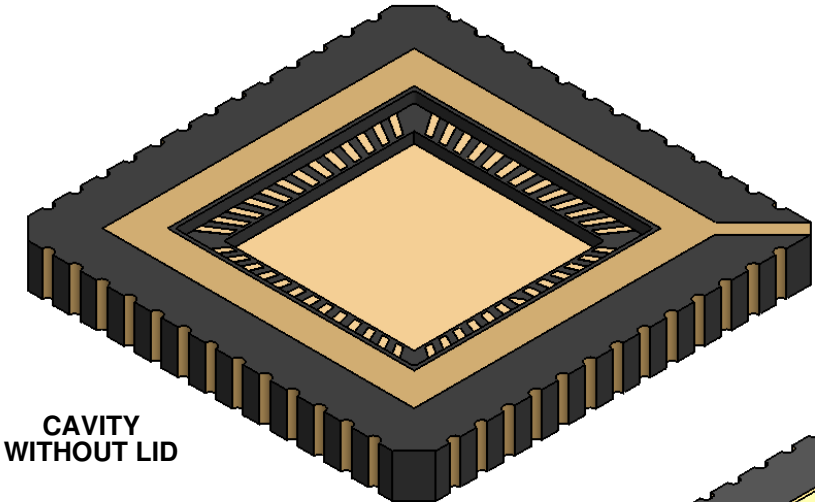
BOND PADS



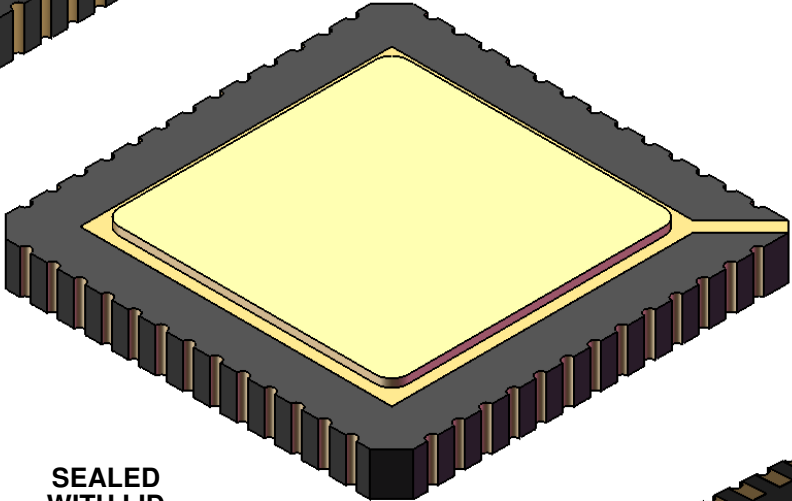
WITHOUT LID

TopLine®			
TITLE LCC52B50SQ.75-N350			
SCALE 10:1	SIZE A	DRAWING NO. 169872	REV A
DO NOT SCALE DRAWING		SHEET 2 OF 4	

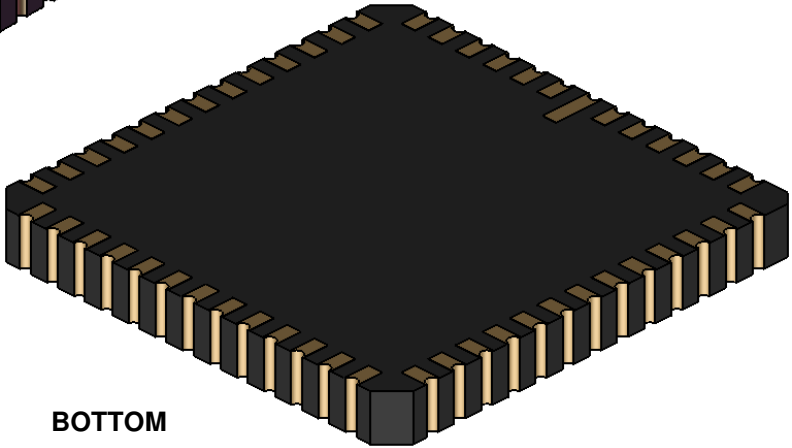
MODELS



**CAVITY
WITHOUT LID**



**SEALED
WITH LID**



BOTTOM

TopLine[®]

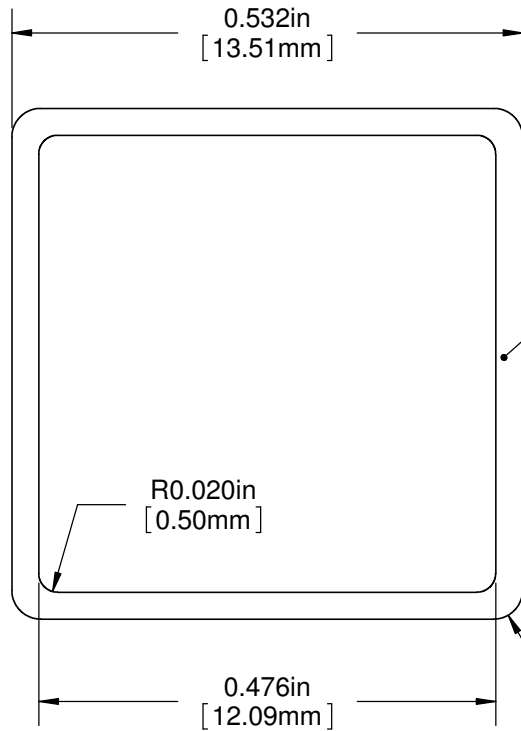
TITLE LCC52B50SQ.75-N350

SCALE 4:1	SIZE A	DRAWING NO. 189872	REV A
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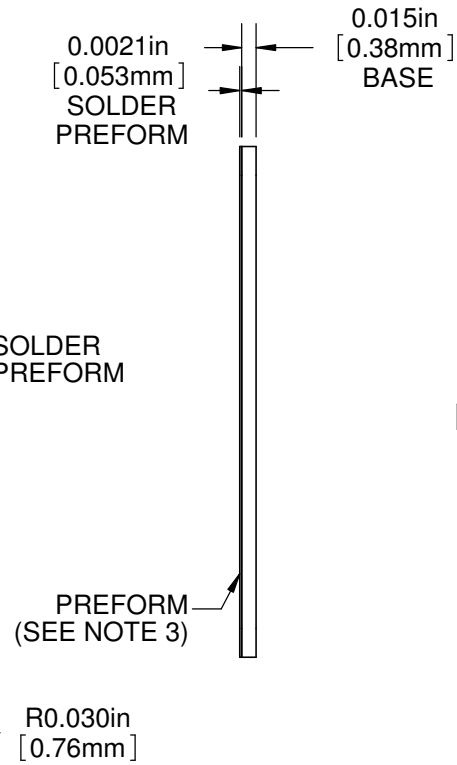
DO NOT SCALE DRAWING SHEET 3 OF 4

COMBO LID

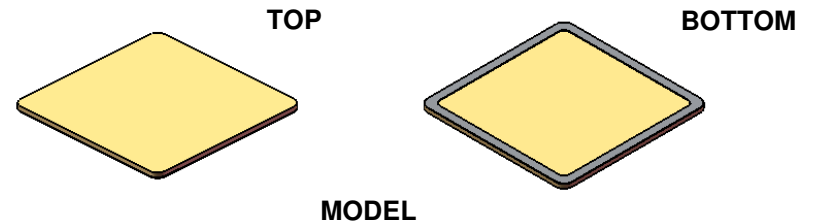
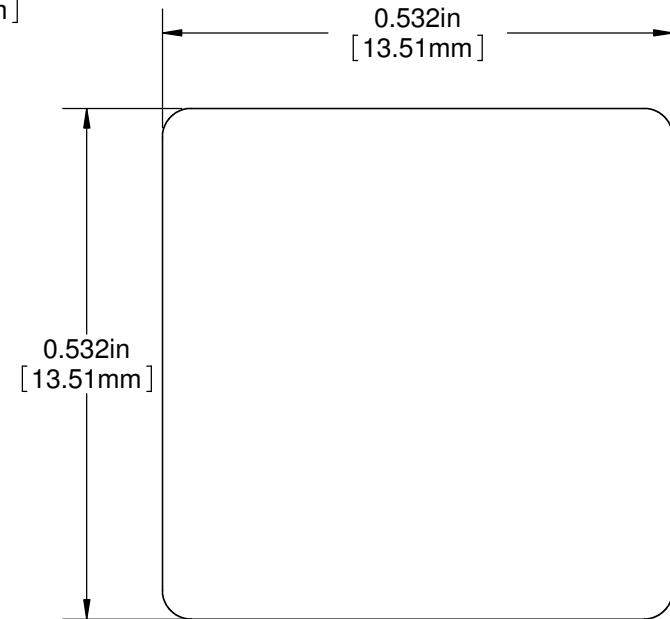
BOTTOM



SIDE



TOP



NOTES:

1. BASE MATERIAL: KOVAR or ALLOY 42.
2. PLATING: Ni 50~350 MICRO-INCH PER SIDE.
Au 25 MICRO-INCH MIN PER SIDE.
3. SOLDER PREFORM: Au 80% ±1.0 Sn 20%.
4. FLATNESS 1.0 MIL (25um) MAXIMUM PER 0.5-inch (12.7mm).

TopLine®			
TITLE		CL-532SQ-A COMBO LID	
SCALE	SIZE	DRAWING NO.	REV
5:1	A	187001	A
DO NOT SCALE DRAWING			SHEET 4 OF 4